

**USER GUIDE** 

# 78M6631 Firmware Description Document

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# 1 Introduction

This document describes the 78M6631 firmware (6631\_3PH\_6S\_URT\_B21), which can be used with the Teridian<sup>™</sup> 78M6631 energy measurement IC. This firmware provides measurements for a 3-phase system along with simple methods for calibration, configuration, and access to metrology data. This document contains the following sections:

- Functional Description: Signal Processing Flow, Functions, Calibration, and Operations
- Configuration and Control: Configurability and Settings
- Communications: Communication Interfaces and Protocols Description

The calculations are done on each of the phases individually and the aggregate measurements are also available as follows:

- Voltage rms (Phase A, B, C)
- Current rms (Phase A, B, C)
- Active Power (Phase A, B, C)
- Apparent Power (Phase A, B, C)
- Reactive Power (Phase A, B, C)
- Power Factor (Phase A, B, C)
- Line Frequency

The firmware also provides measurement results on fundamentals and harmonics. Section 2.2.5 describes how to access and configure harmonics measurements.

The firmware supports Delta and Wye Configurations, the configuration is selectable through a dedicated pin  $(D/\overline{Y})$  of the 78M6631 or by modifying the configuration register.

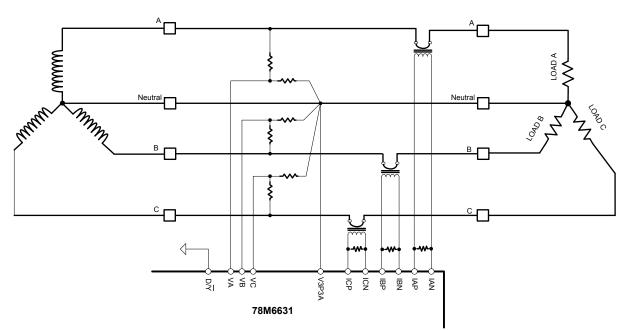


Figure 1. Simplified Connection Diagram of a 3-Phase Wye System

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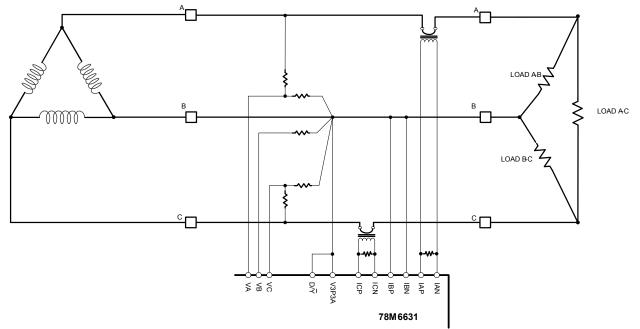


Figure 2. Simplified Connection Diagram of a 3-Phase Delta System

All measurement calculations are computed by the 78M6631 and accessible through serial interfaces: UART0 on the TX and RX pins and the Serial Peripheral Interface (SPI).

On the UART, the CLI (Command Line Interface) handles the serial communications .The CLI provides access to internal data and allows issuing commands through the serial port. Section 3 provides details on serial port default configuration and Section 4 describes the CLI commands.

Note that the firmware does not support I<sup>2</sup>C, RTC (real-time clock), and battery modes.

# 2 Functional Description

This section summarizes the functional operation of the 78M6631 firmware. Refer to the IC data sheet and application notes for more information on terminologies and detailed IC operation.

### 2.1 Initialization and Startup

Upon power-up, both MPU and Compute Engine (CE) cores start executing the application code from designated blocks of flash memory. The parameters and defaults are copied from Flash memory into RAM and accessible (R/W) through the communication interfaces and utilized by the firmware.

After the initialization phase, the firmware starts regular operations and signal processing.

The user can modify any parameters specified as input register, however the modified values are volatile and will be lost during a power-down or reset. To permanently save the value of the input registers it is necessary to store them to flash. A section in this document describes which registers can be saved into flash memory and the relevant command.

### 2.2 Measurements and Signal Processing Flow

### 2.2.1 Description of Measurement Equations

The firmware provides the user with continuously updated measurement data. Table 1 lists the basic measurement equations.

Symbol	Parameter	Equation
V	RMS Voltage	$V = \sqrt{\sum v(t)^2}$
I	RMS Current	$I = \sqrt{\sum i(t)^2}$
Р	Active Power	$P = \sum \left( \dot{\imath}(t) * \imath (t) \right)$
Q	Reactive Power	$Q = \sum (i(t) * vq(t))$
S	Apparent Power	S = V * I
PF	Power Factor	P/S
PA N/A	Phase Angle	ACOS (P/S)

### **Table 1: Measurement Equations Definitions**

The integrated AFE and CE function as a data acquisition system, controlled by the MPU. The lowvoltage analog input signals are sampled and stored in CE DRAM where they are processed by the CE. This firmware utilizes an effective sampling rate of 2521 samples per second. The sampling rate is referred to each individual channel.

The CE, a dedicated 32-bit signal processor, performs the computations necessary to perform all the measurements. The CE calculations and processes include:

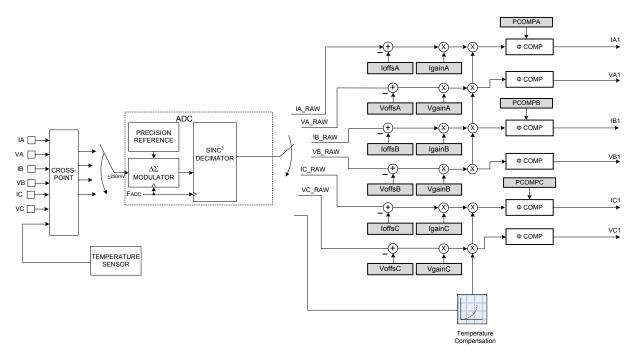
- Multiplication of each current sample with its associated voltage sample to obtain the energy per sample (when multiplied with the constant sample time).
- Frequency-insensitive delay cancellation on all channels (to compensate for the delay between samples caused by the multiplexing scheme).
- 90° phase shifter (for VAR calculations).
- Monitoring of the input signal frequency.
- Monitoring of the input signal amplitude.
- Scaling of the processed samples based on calibration coefficients.

At the end of each accumulation interval, these measurements are provided to the MPU for postprocessing. Alternate multiplexer cycles also gather measurements of the IC's junction temperature for additional compensation in the MPU. Post-processing functions handled by the MPU at the end of every accumulation interval include:

- Compensation for environmental variables
- Calculation of apparent power, power factor, phase angle, and line frequency
- Comparing of measurement outputs to configurable alarm thresholds
- Scaling and formatting of output measurement data
- Updating of all output registers (data and alarm status)

### 2.2.2 Front-End and Input Stage

Figure 3 shows the ADC signal path and signal processing for the voltage and current input channels.



### Figure 3. Input Stage Signal Processing Path

The gray boxes are the gain calibration input registers. These registers can be modified by the user or by the gain calibration routine for both voltage and current channels.

The voltage and current inputs channels are also temperature compensated. A compensation algorithm based on the reading of an on-chip temperature sensor, corrects the gain in order to maintain the accuracy across the temperature range.

The phase compensation block allows to digitally correct phase errors. These errors are usually introduced by the voltage/current transformers or external filters. The phase error is calibrated by introducing a time delay or a time advance, specified in the phase adjust registers. The registers PCompA, PCompB, and PCompC can be modified by the user.

A configurable high-pass filter (HPF) in both voltage and current signal path removes any DC content (offset) in the inputs.

### 2.2.3 Voltage and Current RMS Calculation

As shown in Figure 4, the voltage and current channels ADC output samples are used to continually compute the RMS (root mean square). The RMS is obtained by performing the square sum of the instantaneous samples of voltage and current over a time interval (commonly referred as accumulation time) and then performing a square root of the result:

$$VRMS = \sqrt[2]{\frac{\sum_{n=0}^{N-1} Vn^2}{N}} IRMS = \sqrt[2]{\frac{\sum_{n=0}^{N-1} In^2}{N}}$$

In Figure 4, the output registers are represented in gray.

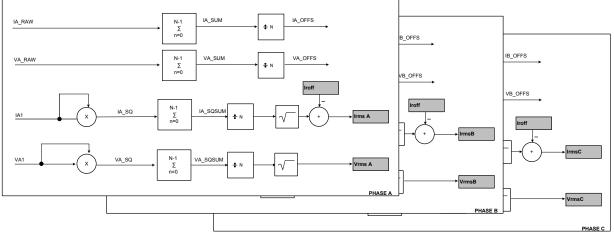


Figure 4. Voltage and Current RMS Calculations

#### 2.2.4 Active, Reactive and Apparent Power Calculation

Figure 5 shows the signal processing chain for active and reactive power calculations.

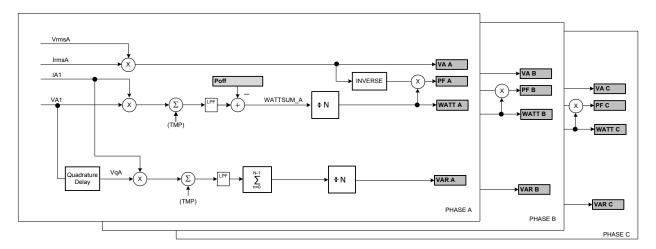


Figure 5. Power and Power Factor Signal Processing Chain

#### **Active Power**

The instantaneous power is obtained multiplying instantaneous voltage and current samples. The product is then averaged over N conversions (accumulation time) to compute active power (WATTA, WATTB and WATTC), the aggregate value (WATTS) is the sum of the 3 phases active power average.

#### **Apparent Power**

The apparent power (VA-A, VA-B, VA-C) is the product of rms voltage (VrmsA, VrmsB, and VrmsC) and rms current (IrmsA, IrmsB, IrmsC):

$$VA = I_{RMS} \times V_{RMS}$$

#### **Reactive Power**

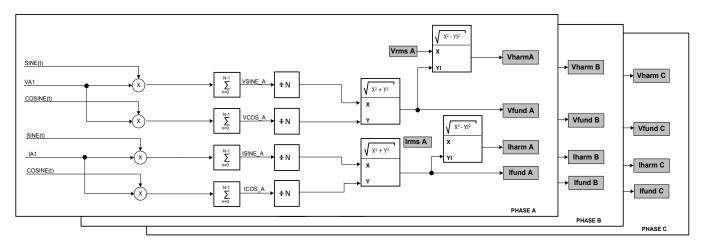
The reactive power is calculated as multiplication of instantaneous samples of current (IA1, IB1, IC1) and the instantaneous quadrature voltage (VqA, VqB, VqC). The quadrature voltage is obtained through a 90° phase shift (quadrature delay) of the voltage samples. The samples are then averaged over the accumulation time interval and updated in the VARA, VARB, and VARC registers.

### 2.2.5 Voltage and Current Harmonics and Fundamental Measurement

The 78M6631 firmware allows measurement of the harmonic and fundamental components. To enable the harmonics and fundamental measurements bit 5 of the command register must be set to 1.

Harmonic voltage (Vharm) and current (Iharm) are calculated with the quadratic subtraction of the Fundamental results from the RMS results (the square root of RMS squared minus Fundamental squared).

Figure 6 shows the harmonic and fundamental components.





#### 2.2.6 Power Harmonics and Fundamental Measurement

Harmonic Power (Pharm) is calculated by subtracting Fundamental Power (Pfund) from total active power (Watts).

Quadrature Harmonic Power (Qhram) is calculated by subtracting Fundamental Quadrature Power (Qfund) from Total Reactive Power (VARs).

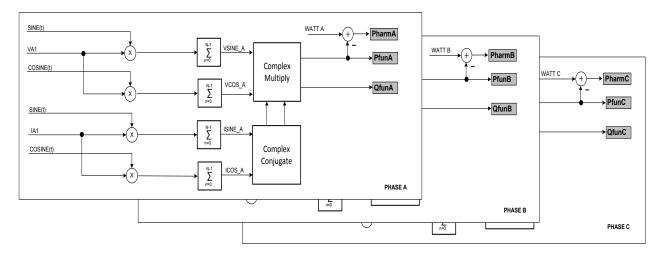


Figure 7. Power Harmonic and Fundamental Measurements

### 2.2.7 Power Factor Calculation

The 78M6631 provides a direct power factor measurement simultaneously for phase A, phase B, and phase C. Power factor in an AC circuit is defined as the ratio of the active power flowing to the load to the apparent power. The power factor measurement is defined in terms of "import" or "export" referring to the direction of the power in the system.

Power factor is reported for all phases, and a weighted average is also provided. All values will be between -1.0 and +1.0 and can be scaled by the user to the desired resolution.

### 2.2.8 Line Frequency

Frequency (FREQ) is both an input register and an output (result) register (low-rate). If the bit "FREQ" (Command Register bit 4) is set to 0, the line frequency (measured from a phase reference) is stored in this variable. If bit "FREQ" is instead set to 1, the value contained in this register will be utilized by the firmware. The default value is in this case 60Hz, and can be modified by the user.

This variable is used to set the frequency of the sine/cosine generator for fundamental and harmonic calculations. It can also be set to a harmonic or an arbitrary unrelated frequency to measure the amplitude of that frequency.

Phase Reference: The phase reference is calculated on the difference VA-VB-VC.

### 2.2.9 Accumulation Interval

The low-rate calculation/results are performed over a time interval referred as accumulation interval. The accumulation interval can be modified by the user through Accum Register. The Accum register is an unsigned integer containing the minimum number of high-rate samples that define the low-rate interval. For example, with a value of 0x7D0 the accumulation interval results in:

Accumulation Inteval =  $\frac{1}{Sample Rate} * Accum$ 

Resulting in an accumulation interval of 793 ms.

### **Effective Accumulation Interval**

The register Divisor reports the value of the effective accumulation interval as number of high-rate samples. Referring to the processing flow diagrams, it represents the divisor (N) for low-rate accumulated results.

### Line-Lock

The Command Register bit "LINELOCK" can be used to lock the low-rate interval to incoming Line Voltage Cycles. When set, the low-rate sample period will end after the first low-to-high zero crossing of the Phase A Voltage input occurs after the Minimum Accumulation time has elapsed. The Actual Accumulation Interval will span an integer number of line cycles.

When LINELOCK is not set, the Accumulation Interval will equal the number of high rate samples specified in the Accum register.

### 2.2.10 Zero Crossing Detector

The polarity of the Phase Reference is used by the zero-crossing detection logic to determine the start and end of consecutive line cycles. It is used for frequency measurement, to determine the backstep for quadrature voltage delay lines, and to lock the low-rate computation cycle to the line frequency. A 3/4-cycle holdoff timer is used to prevent noise and harmonics from registering as additional zero crossings.

### 2.2.11 Sine and Cosine Reference

An internal Sine/Cosine oscillator generates waveforms used by the fundamental and harmonic result calculations. The frequency of this oscillator is set by the FREQ variable. It is generally set to the line frequency. The phase is unrelated and unimportant.

### 2.2.12 High-Pass Filters

An alternative to offset calibration is dynamic offset removal. This can be accomplished with either lump-sum removal or a more gradual averaged reduction. The latter is similar to high-pass filtering, but without phase distortion. All three methods are controlled by the HPF coefficient register. This is a 9 bit value indicating how much of the measured offset (median) to remove each low-rate sample period.

When HPFcoeff = 0, the last value in the offset registers is subtracted from the respective inputs. This is the state that offset calibration uses. When HPFcoeff = 1.0 (0x100) the offset registers are loaded with the measured offset (median) every low-rate sample. This is lump-sum offset removal. When HPFcoeff is a fraction – say .75 (0xc0), 75% of the measured offset and 25% of the old register value is used. Low values of HPFcoeff give very low HPF corner frequencies.

### 2.3 Configuration and Control

### 2.3.1 Input Registers

The following parameters are configurable by the user via input registers:

- Sensor range and configuration
- Calibration targets and coefficients
- Alarm Thresholds and Mask Settings

### 2.3.2 Sensors Configuration

A few parameters specific to the voltage and current sensors and their connections require one time configuration.

### Sensor Output Range

The sensor's output needs to be adapted to the ADC input range (+/- 250mVpk). In case of a Current Transformer (CT), the burden resistor value should be selected in order to match the maximum ADC input voltage at the maximum load current that need to be measured. Similarly consideration applies for the voltage sensor (Voltage Dividers or Voltage Transformers).

### **Delta/Wye Configuration Selection**

The different connections can be selected through the external dedicated  $D/\overline{Y}$  pin or through commands over the UART or SPI interfaces. At power-on or reset the  $D/\overline{Y}$  pin is sampled and its status determines the set of equations enabling the proper configuration. After the initialization, the configuration can then be changed by the user through the command register. Bit 2 (Delta) set to 0 selects the Wye configuration while Bit 2 set to 1 selects the Delta configuration.

The status of the Delta bit in the command register is always overwritten at power-on with the status of the  $D/\overline{Y}$  pin.

### 2.3.3 Updating Flash

The values of several input registers can be updated by the user at run-time. A flash update routine is provided to save the values of various registers as default. To save the registers values to flash memory, see the section describing the command register.

### 2.3.4 Scaling

Scaling registers provide a means for the user to adapt the meaning of the results to the end application. There are separate scaling registers for RMS voltage, RMS current, power, and power factor, but each register covers all three phases.

By default, scaling registers are set so that result LSBs represent one millivolt, milliamp, or milliwatt, millihertz, Power factor is scaled to 1 LSB = .001.

### Example

The scaling registers contain full-scale values in units selected by the user. For example, 50 amps full scale with a resolution of 1 milliamp will be a scaling register value of 50000.

### 2.3.5 Calibration

As with any measurement system, there are also multiple sets of coefficients that are used to compensate for system inaccuracies. Input registers for all coefficients can be manually modified and saved to flash. Alternatively, high level calibration routines can be invoked. These routines automatically determine the coefficients for common parameters and save them to flash memory. The different types of compensation parameters include:

- Voltage: gain and offset for voltage sense circuit
- Current: gain and offset for current sense circuit
- Phase: voltage-to-current phase offset introduced by transformer or filters in sense circuits
- Temperature: offset for junction temperature at room temp
- Temperature: coefficients for temperature curve
- RMS and Power offset: fixed offsets for voltage and current and power at light loads

The calibration routines compensate for sensors and system inaccuracy. The new coefficients computed during calibration can be stored in the on-chip flash.

In order to perform a calibration, an external stable AC source (Voltage/Current) and AC load are required. The calibration routines have a target voltage and current (Register Itarget) used for all phases to match. The target calibration voltage and current values are specified in the registers Vtarget and Itarget.

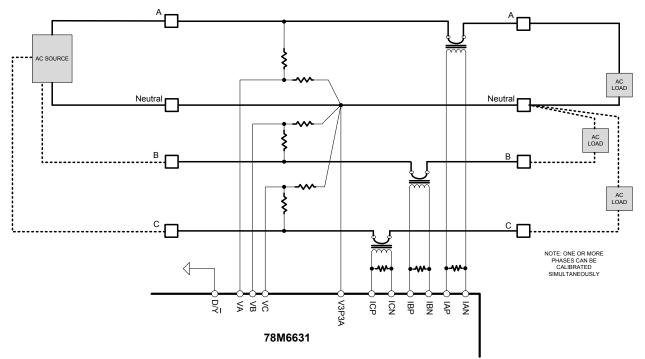


Figure 8. 3-Phase System Calibration Test Setup Example

To calibrate the voltage and current the following steps are required:

- **AC Source and Load**: The calibration routine needs a stable source and load. The source and load can be applied to a single phase, two phases or all three phases.
- Selection of Target Values: Before launching the calibration the target value (voltage/current) must be set. During calibration the gains will be adjusted to match the target voltage and/or current.
- Selection of the Gain to Calibrate and Launch: the gain calibration can be performed on one phase or multiple phases and can be voltage, current or both simultaneously. The control register allows the selection of the channel to calibrate and the launch of the calibration routine.

Upon a successful calibration the command register will have the bits set for calibration reset to 0.

Upon unsuccessful calibration the command register will have the bits set for all failing channels.

### 2.3.6 Phase Error Compensation

The 78M6631 is designed to function with a variety of current transducers, including those that induce inherent phase errors. A phase error of 0.1° to 0.3° is not uncommon for a current transformer (CT). These phase errors can vary from part to part, and they must be corrected to achieve accurate power readings. The errors associated with phase mismatch are particularly noticeable at low power factors. The 78M6631 provides a means of digitally calibrating these small phase errors by introducing a time delay or a time advance.

A Phase Compensation register is provided for each of the 3 phases. The range for phase compensation is  $\pm 20^{\circ}$  at 50 Hz. Phase compensation registers are set to 0.0 by default. Positive values increase delay on voltages relative to currents. The default is ideal when using resistive shunts for current measurement. But a compensation value will be required to compensate for the induced delay of a current transformer or external filter.

Phase compensation registers use a signed (two's complement) fixed-point notation. Bits 15:0 are the fractional part and bits 31:16 are the integer part. The range is -3.0 to +3.999 high-rate samples. The phase compensation registers are PhComp A, PhComp B, and PhComp C.

### 2.3.7 Limit (Alarms) Settings

The Limit registers set limits on result values causing Status Register bits to be set when a limit threshold is exceeded. Limit registers use the same scaling applied to results and, as such, are user-definable.

### Sticky Bits

The user has the option to choose which Status Register bits will clear automatically once an alarm condition no longer exists. Each bit in the Sticky Register corresponds to the same bit in the Status Register. When a Sticky bit is set, the same bit in the Status register will not clear automatically. They can only be cleared by writing the Status Register.

### 2.3.8 Creep Threshold

The 78M6631 includes a "no-load" detection feature that eliminates what is commonly referred as "meter creep." Meter creep is defined as power (or energy) that is read by the system when there is no load attached. The FW sets the current to zero reading when its value falls below the programmable threshold.

### 2.3.9 Digital I/O Configuration

Five digital I/Os (DIOs) can be controlled by the user through the serial communication interfaces. These digital I/Os are set as output and their logic levels are controlled through MASK registers. See Section 5.4.4.

# 3 Serial Peripheral Interface (SPI)

The 78M6631 has an on-chip SPI interface. The interface is slave (only) and can communicate directly on the MPU data bus without FW overhead.

A typical SPI transaction is as follows: While PCSZ is high, the port is held in an initialized/reset state. During this state, PSDO is held in high-Z state and all transitions on PCLK and PSDI are ignored. When PCSZ falls, the port will begin the transaction on the first rising edge of PCLK. A transaction consists of an 8-bit command, a 16-bit address, and then one or more bytes of data. The transaction ends when PCSZ is raised. Some transactions may consist of a command only.

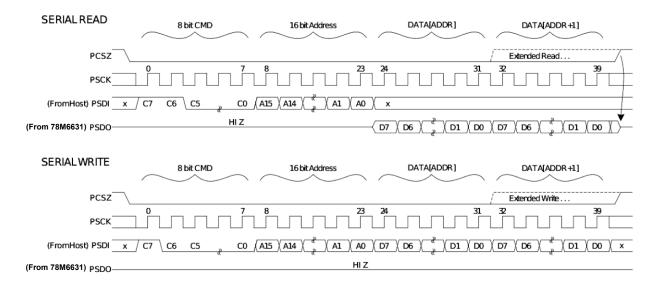


Table 2: SPI	Command	Description
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Command	Description
11xx xxxx ADDR D0 DN	Output data on PSDO is read from RAM starting with byte at ADDR.
	ADDR will auto-increment until PCSZ is raised.
	MPU SPI interrupt is generated if xx xxxx is not equal to 0.
1100 0000 ADDR D0 DN	Output data on PSDO is read from RAM starting with byte at ADDR.
	ADDR will auto-increment until PCSZ is raised.
	No MPU SPI interrupt is generated because xx xxxx equals 0.
10xx xxxx ADDR D0 DN	Input data on PSDI is written to RAM starting with byte at ADDR.
	ADDR will auto-increment until PCSZ is raised.
	MPU SPI interrupt is generated if xx xxxx is not equal to 0.
1000 0000 ADDR D0 DN	Input data on PSDI is written to RAM starting with byte at ADDR.
	ADDR will auto-increment until PCSZ is raised.
	No MPU SPI interrupt is generated because xx xxxx equals 0.
CMD ADDR D0 DN	CMD and ADDR are available to the CPU in IORAM
	D0 DN are ignored.
	MPU SPI interrupt is generated

# 4 Serial Communication and CLI

The serial communication with the 78M6631 takes place over a UART (UART0) interface. The default settings for the UART of the 78M6631, as implemented in this firmware, are given below:

Baud Rate:38400bpsData Bits:8Parity:NoneStop Bits:1Flow Control:None

The host's serial interface port is required to implement these settings on its UART. To verify communication between the host and the 78M6631, the host must send a <CR> (carriage return) to the 78M6631. Communication is verified when the 78M6631 returns a > (greater than sign) known as the command prompt. An example is given below:

The host sends the following to the 78M6631:

<CR>

The 78M6631 sends the following back to the host:

>

### 4.1 CLI Interface

The Command Line Interface (CLI) provides a simple ASCII interface to access input and output registers and to invoke commands. The CLI interface connects to a HyperTerminal or any other terminal emulation SW. The CLI interface can also be used to interface to a host processor.

# 5 Register Descriptions

All register are 32 bits (4 bytes) and are on "longword" (4 byte) boundaries. All register addresses are the same internally for both SPI and CLI (UART) user interfaces. However, the SPI interface has the ability to address individual bytes while the CLI interface can only address entire longwords. So SPI addresses contain two extra low order bits.

### 5.1 Command Register

Command register can be accessed through UART/CLI (address 0x42) or SPI (address 0x108). The Command Register allows the user to select voltage or current channels to be calibrated. Also allows enabling or disabling of harmonic/fundamental measurements. The following table shows the Command Register bit assignment. The default value of the Command Register is 0x00000000.

Bit	Name	Flash Stored	Description	
31	_	N	CE reserved	
30:28	_	N	MPU reserved	
27	CO	N	Calibrate Offset	
26	VA	N	Select VA Channel For Calibration	
25	VB	N	Select VB Channel For Calibration	
24	VC	Ν	Select VC Channel For Calibration	
23	-	N	Not Used	
22	IA	N	Select IA Channel For Calibration	
21	IB	N	Select IB Channel For Calibration	
20	IC	N	Select IC Channel For Calibration	
19	CG	N	Calibrate Gain Command (1=calibrate)	
18	СТ	Ν	Calibrate Temperature	
17:6	_	N/A	MPU reserved	
5	FUND	Y	Enable Fundamental/Harmonic Calculations	
4	FREQ	Y	Allow Frequency to set Sine/Cosine period	
3	LINELOCK	Y	Locks low rate period to line cycles	
2	YD	Y	Selects DELTA / WYE Configuration 0=Wye ; 1=Delta	
1:0	_	N/A	CE reserved	

### 5.2 Status Register

The status register contains alarms and system status flags that can be monitored by the host processor. Alarms thresholds can be set through the corresponding registers.

St	atus Register	CLI Address 0xF5	SPI Address 0x3D4			
Bit	Desc	ription / Comment				
1, 0		Not Used				
2	Minimum Tempera	ture Alarm (Under	Temperature)			
3	Maximum Tempera	ature Alarm. (Over <sup>-</sup>	Temperature)			
4	Unde	erCurrent phase C				
5	Unde	erCurrent phase B				
6	Unde	erCurrent phase A				
7	Ove	erCurrent phase C				
8	Ove	rCurrent phase B				
9	9 OverCurrent phase A					
10	10 Voltage Imbalance phase C					
11	Voltage Imbalance phase B					
12	Voltage Imbalance phase A					
13	Unde	er-Voltage phase C				
14	Unde	er-Voltage phase B				
15	Unde	er-Voltage phase A				
16	Over	r-Voltage phase C				
17	Over	r-Voltage phase B				
18	Over	r-Voltage phase A				
20	Powe	er Factor phase C				
21	Powe	er Factor phase B				
22	Powe	er Factor phase A				
23 -30		Not Used				
31	C	command Done				

### **Sticky Bits Register**

The sticky bit register at address 0xF3 (CLI) and 0x3CC (SPI) allows the user to set the mode of the status register bit. Each bit can individually be programmed to clear automatically once an alarm condition no longer exists or to holds its status until cleared by writing to the status register.

# 5.3 Measurement Results Register

Output	CLI Address (hex)	LSB	SPI Address (hex)	LSB	Comment	
Temperature	18A		628		Die Temperature	
Frequency	151		544	Hz	Line frequency (unsigned)	
Divisor	44		110		Effective Accumulation Interval (number of high-rate cycles)	
Vrms A	154		550	mVrms	rms voltage Phase A (unsigned)	
Vrms B	156		558	mVrms	rms voltage Phase B (unsigned)	
Vrms C	158		560	mVrms	rms voltage Phase C (unsigned)	
Irms A	155		554	mArms	rms Current Phase A (unsigned)	
Irms B	157		55C	mArms	rms Current Phase B (unsigned)	
Irms C	159		564	mArms	rms Current Phase C (unsigned)	
Irms	153		548	mArms	rms Current Total (unsigned)	
Watt A	164		590	mW	Active Power Phase A	
Watt B	165		594	mW	Active Power Phase B	
Watt C	166		598	mW	Active Power Phase C	
Watts	167		59C	mW	Total active power	
VA-A	16C		5B0	mW	Apparent power - phase A (unsigned)	
VA-B	16D		5B4	mW	Apparent power - phase B (unsigned)	
VA-C	16E		5B8	mW	Apparent power - phase C (unsigned)	
VAs	16F		5BC	mW	Total apparent power	
VarA	168		5A0	mW	Reactive power - phase A	
VarB	169		5A4	mW	Reactive power - phase B	
VarC	16A		5A8	mW	Reactive power - phase C	
Vars	16B		5AC	mW	Total reactive power	

Output Register	CLI Address (hex)	LSB	SPI Address (hex)	LSB	Comment	
PFA	15A		568		Power Factor Phase A	
PFB	15B		58C		Power Factor Phase B	
PFC	15C		570		Power Factor Phase C	
VfundA	180		600	mVrms	Fundamental rms voltage Phase A (unsigned)	
VfundB	181		604	mVrms	Fundamental rms voltage Phase B (unsigned)	
VfundC	182		608	mVrms	Fundamental rms voltage Phase C (unsigned)	
lfundA	178		5E0	mVrms	Fundamental rms voltage Phase A (unsigned)	
lfundB	179		5E4	mVrms	Fundamental rms voltage Phase B (unsigned)	
lfundC	17A		608	mVrms	Fundamental rms voltage Phase C (unsigned)	
lfund	17B		5EC	mVrms	Fundamental rms voltage (Aggregate) (unsigned)	
PfundA	170		5C0	mVrms	Active Fundamental power A	
PfundB	171		5C4	mVrms	Active Fundamental power B	
PfundC	172		5C8	mVrms	Active Fundamental power C	
Pfund	189		624	mVrms	Active Fundamental power (Aggregate)	
QfundA	186		618	mVrms	Reactive Fundamental power A	
QfundB	187		61C	mVrms	Reactive Fundamental power B	
QfundC	188		620	mVrms	Reactive Fundamental power C	
Qfund	189		624	mVrms	Reactive Fundamental power (Aggregate)	
VharmA	183		60C	mVrms	Harmonic voltage – phase A (unsigned)	
VharmB	184		610	mVrms	Harmonic voltage – phase B (unsigned)	
VharmC	185		614	mVrms	Harmonic voltage – phase C (unsigned)	
IharmA	17C		5F0	mVrms	Harmonic current phase A	
IharmB	17D		5F4	mVrms	Harmonic current phase B	
IharmC	17E		5F8	mVrms	Harmonic current phase C	
Iharm	17F		5FC	mVrms	Harmonic current (Aggregate)	
PharmA	174		5D0	mVrms	Active Harmonic power A	
PharmB	175		5D4	mVrms	Active Harmonic power B	
PharmC	176		5D8	mVrms	Active Harmonic power C	
Pharm	177		5DC	mVrms	Active Harmonic power (Aggregate)	

### 5.3.1 High-Rate Results Registers

There is a set of registers that are updated at a high rate. Although accessible by both UART and SPI, it is recommended to use SPI. The SPI interface if faster than the UART and does not require any FW overhead and latency, having direct access to the memory.

Register Name	CLI Addr (Hex)	SPI Addr (Hex)	Description
VA	10	40	Voltage – Phase A
VB	20	80	Voltage – Phase B
VC	30	C0	Voltage – Phase C
VqA	11	44	Quadrature Voltage A
VqB	21	84	Quadrature Voltage B
VqC	31	C4	Quadrature Voltage C
IA	12	48	Current – Phase A
IB	22	88	Current – Phase B
IC	32	C8	Current – Phase C
Vsine	40	100	Sine reference
Vcosine	41	104	Cosine reference

### 5.4 Parameters Configuration

These registers are defined as input registers. The values of the input registers can be updated by the user at run-time. A flash update routine is provided to save the values of various registers as default (check the Flash Stored column in the following tables).

### Save Input Register Values to Flash Memory

To save the register values to flash memory, it is necessary to write the following value to the Command Register: 0x5920008. Once saved, the latest saved values will become the new defaults.

### 5.4.1 Scaling

Input Register	CLI Address (Hex)	SPI Address (Hex)	Scaling	Notes	Flash Stored	Default
Iscale	101	404	Scaling for RMS currents	unsigned	Y	50000
Vscale	100	400	Scaling for RMS voltages	unsigned	Y	667000
Pscale	102	408	Scaling for Power results	unsigned	Y	33350000
PFscale	117	45C	Scaling for Power Factor	unsigned	Y	1000
Fscale	107	41C	Scaling for Frequency	unsigned	Y	1000
Tscale	108	420	Scaling for Temperature	unsigned	Y	1000

### 5.4.2 Alarms Limit Setting

Input Register	CLI Address (Hex)	SPI Address (Hex)	Alarm Limits (Note: 0* disables item)	Notes	Flash Stored	Default
IrmsMax	10A	428	Maximum RMS current/phase	unsigned	Y	0
VrmsMax	10C	430	Maximum RMS voltage/phase	unsigned	Y	0
IrmsMin	109	424	Minimum RMS current/phase	unsigned	Y	0
VrmsMin	10B	42C	Minimum RMS voltage/phase	unsigned	Y	0
PFmin	10E	438	Minimum Power Factor/phase	unsigned	Y	0
Tmin	10F	43C	Minimum Temperature		Y	0
Tmax	110	440	Maximum Temperature		Y	0
VmaxDelta	10D	434	Maximum line-to-line Voltage Imbalance	unsigned	Y	0

### 5.4.3 Phase Error Compensation

Input Register	CLI Address (Hex)	SPI Address (Hex)	Phase Compensation	Notes	Flash Stored	Default
PcompA	104	410	Phase compensation A	signed	Y	0
PcompB	105	414	Phase compensation B	signed	Y	0
PcompC	106	418	Phase compensation C	signed	Y	0

Input Register	CLI Address (Hex)	SPI Address (Hex)	Phase Compensation	Notes	Flash Stored	Default
Mask1	111	444	DIO3 Control	Boolean	Y	0
Mask2	112	448	DIO14 Control	Boolean	Y	0
Mask3	113	44C	DIO15 Control	Boolean	Y	0
Mask4	114	450	DIO17 Control	Boolean	Y	0
Mask5	115	569	DIO43 Control	Boolean	Y	0

## 5.4.4 Digital I/O Configuration

# 5.4.5 Calibration and Configuration Variables

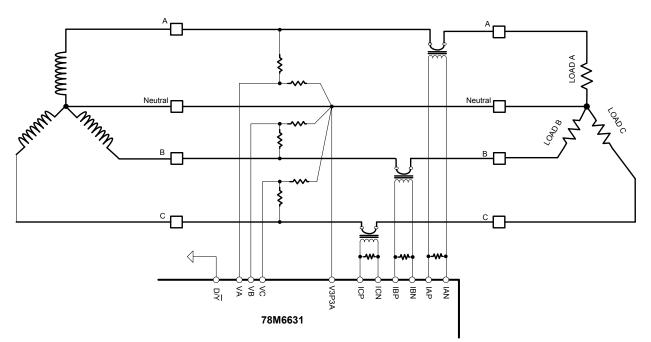
Input Register	CLI Address (Hex)	SPI Address (Hex)	Calibration Variables	Notes	Flash Stored	Default
HPFcoeffl	103	40C	High-pass filter coefficient (Current)	unsigned	Y	0x100
HPFcoeffV	11F	47C	High-pass filter coefficient (Voltage)	unsigned	Y	0x100
Itarget	118	460	Calibration target for RMS currents	unsigned	Y	50000
Vtarget	119	464	Calibration target for RMS voltages	unsigned	Y	667000
Ttarget	11A	468	Calibration target for Temperature	unsigned	Y	22000
Toffs	11C	470	Offset for Temperature	signed		0
Accum	43	10C	Accumulation Interval	unsigned	Y	2000
CalCyc	11B	46C	Calibration Cycles to Average	unsigned	Y	5
Tgain	F8	3E0	Temperature gain (DegScale)	signed		2768
Tnom	FB	3EC	Nominal Temperature	signed	Y	0xD000000
Tcurr	FC	3F0	Current Temperature	signed		
IgainA	14	50	Gain calibration for A current	unsigned	Y	0x4000
IgainB	24	90	Gain calibration for B current	unsigned	Y	0x4000
IgainC	34	D0	Gain calibration for C current	unsigned	Y	0x4000
VgainA	13	4C	Gain calibration for A voltage	unsigned	Y	0x4000
VgainB	23	8C	Gain calibration for B voltage	unsigned	Y	0x4000
VgainC	33	CC	Gain calibration for C voltage	unsigned	Y	0x4000
loffsA	16	58	Offset calibration for A current	signed	Y	0
IoffsB	26	98	Offset calibration for B current	signed	Y	0
loffsC	36	D8	Offset calibration for C current	signed	Y	0
VoffsA	15	54	Offset calibration for A voltage	signed	Y	0
VoffsB	25	94	Offset calibration for B voltage	signed	Y	0
VoffsC	35	D4	Offset calibration for C voltage	signed	Y	0
Iroff	11D	474	Current RMS Offset Adjust	unsigned	Y	0
Poff	11E	478	Power Offset Adjust	unsigned	Y	0

# 6 System Connection Diagram Examples

This section shows supported 3-phase connections and configurations

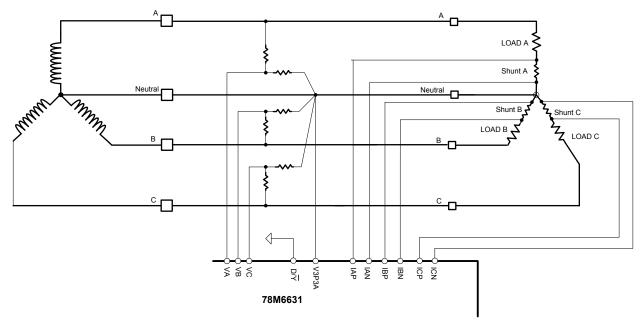
#### 3-Phase 4-Wire

The 3-phase 4-wire configuration has a connection point (neutral) for the three phases, as shown in the following figure. The neutral is connected to the V3P3, the reference potential for voltage and current measurement. This configuration utilizes three current transformers (CT) for the measurement of the current on each phase; the phase voltage is sensed through resistor-dividers.



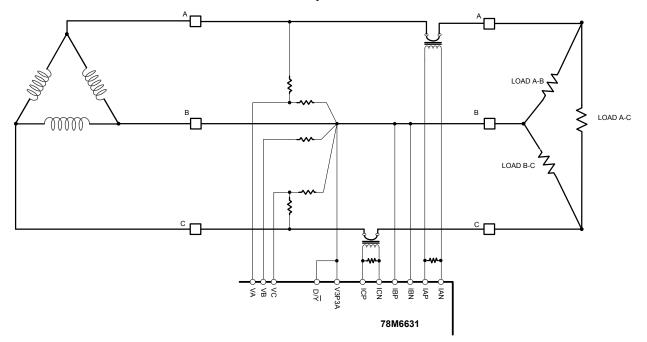
### 3-Phase 4-Wire (Shunt)

An alternative to the previous configuration, the following figure shows a low-cost solution that is shuntbased. As the previous configuration, the neutral is connected to V3P3 and is the reference potential for both current and voltage measurements. The differential current inputs simplify the connections of the shunt to the system.



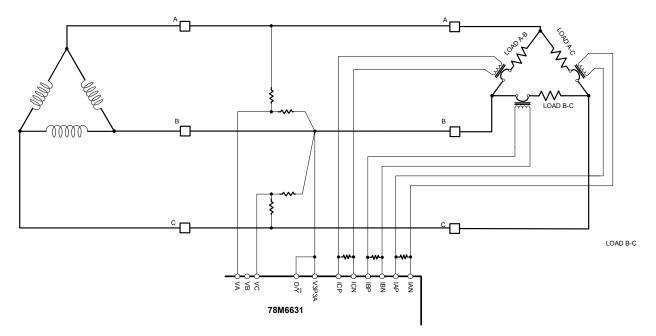
### **Non-Isolated Basic Delta Connection**

The system is referenced to a phase (in this case phase B). The currents are sensed at the phases A and C, and the third current is calculated. Although this implementation allows only two CTs, it does not allow the measurement of current of each load individually.



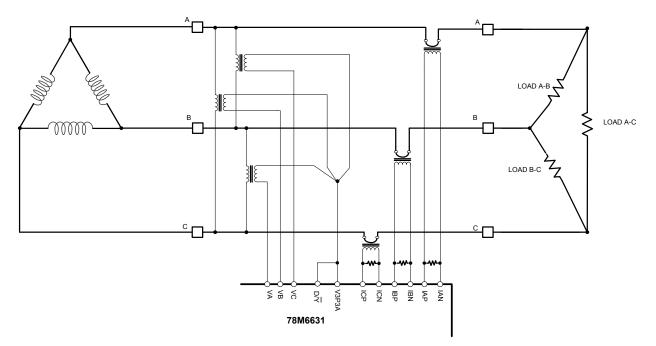
### Non-Isolated Basic Delta Connection (alternative configuration)

The system is referenced to a phase (in this case phase B). The currents are sensed inside the load to determine the individual load current value.



### **Isolated Basic Delta Connection**

In this case, the 78M6631 is completely isolated. This configuration requires 3 voltage transformers and 3 current transformers. This configuration allows the measurement of the current of the individual loads A-B, B-C, A-C.



# 7 Command Line Interface (CLI) Description

The 78M6631 firmware implements an interface/protocol to the user or host called Command Line Interface (CLI). This interface facilitates communication via UART between the 78M6631 and the host processor. The CLI provides a set of commands which are used by the host to configure and to obtain information from the 78M6631.

### 7.1 Identification and Information Commands

The I command is used to identify the revisions of demo code and the contained CE code. The host sends the I command to the 78M6631 as follows:

>I<CR>

The 78M6631 will reply to the host the following:

TSC 78M6631 rev B725

>

## 7.2 Reset Commands

A soft reset of the 78M6631 can be performed by using the Z command. The soft reset restarts code execution at addr 0000 but does not alter XRAM contents. The soft reset also sets all the registers to their default values. To issue a soft reset to the 78M6631, the host sends the following:

>Z<CR>

The W command acts like a hardware reset. The energy accumulators in XRAM will reset back to zero.

Z	Reset		
Description:	Allows the user to cause soft resets.		
Usage:	Z	Soft reset.	
	W	Simulates watchdog reset.	

## 7.3 Data Access Commands

All the measurement calculations are stored in the data range of the 78M6631. The host requests measurement information using the data access command which is a right parenthesis

)

To request information, the host sends the data access command, the address (in hex) which is requested, the format in which the data is desired (Hex or Decimal) and a carriage return. The contents of the addresses that would be requested by the host are contained in Section 5.

### 7.3.1 Individual Address Read

The host can request the information in hex or decimal format. In an address read command, the character \$ requests the information to be returned in hex format. While the character ?, requests information to be returned in decimal. When requesting information in decimal, the data is preceded by a + or a -. The exception is )AB? which returns a string (see the <u>AB</u> description).

An example of a command requesting the measured output located at address 0x28 in decimal is as follows:

>)28?<CR>

An example of a command requesting the measured output located at address 0x28 in hex is as follows:

>)28\$<CR>

### 7.3.2 Consecutive Read

The host can request information from consecutive addresses by adding additional ? for decimal or additional \$ for hex.

An example of requests for the contents in decimal of ten consecutive addresses starting with 0x32 is:

>)32???????<CR>

An example of requests for the contents in hex of ten consecutive addresses starting with 0x12 would be:

#### >)32\$\$\$\$\$\$\$<CR>

Note: The number of characters per line is limited to no more than 60.

### 7.3.3 Block Reads

The block read command can also be used to read consecutive registers. For decimal format: )startaddress:endaddress?

For hexadecimal format: )startaddress:endaddress\$

The following block read command requests a block of measurement information in decimal format:

>)20:3D?<CR>

### 7.3.4 Concatenated Reads

Multiple commands can also be added on a single line. Requesting information in decimal from two locations and the block command from above are given below:

>)32?)35?)20:2E?<CR>

Note: The number of characters per line is limited to no more than 60.

### 7.3.5 Repeat Command

The repeat command can be useful for monitoring measurements and is efficient in demands from the host.

If the host requests line frequency, alarm status, Irms overcurrent event count, Vrms overvoltage event count, voltage, power, and accumulated energy measurements with the following command string:

#### >)21??????<CR>

If the host then desires this same request without issuing another command, the repeat command can be used:

>, (no carriage return needed for the repeat command)

The host only needs to send one character rather than an entire string.

	Auxiliary	
Description:	Various	
Commands:	,	Typing a comma (",") repeats the command issued from the previous command line. This is very helpful when examining the value at a certain address over time, such as the CE DRAM address for the temperature.
	1	The slash ("/") is useful to separate comments from commands when sending macro text files via the serial interface. All characters in a line after the slash are ignored.

# 8 Contact Information

For more information about Maxim products or to check the availability of the 78M6631, contact technical support at <u>www.maxim-ic.com/support</u>.

### **Revision History**

Revision	Date	Description
1.0	7/28/2011	First publication.
1.1	8/11/2011	In Section 5.2, corrected the table. In Section 5.3, changed the CLI Address for Irms from 152 to 153. Also changed the Comment to "rms Current Total".
2	10/10/2011	In Section 5.3, changed the Comment for Watts (Hex 167) to "Total active power".